



Note:

1. Material:

- 1.1 Housing: High temperature thermoplastic with g.f. UL94v-0
- 1.2 Contact: copper alloy, t=0.15mm
- 1.3 Shell: copper alloy, t=0.30mm

2. Specification:

- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 50 mW Max.
- 2.4 Insulation resistance: 100 MW Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min. after 10000 insertion/extraction cycles
- 2.7 Temperature range: -30°C~80°C

鉦創科技有限公司 TRONTEK TECHNOLOGY CO., LTD.			
TOLERANCE: XX ±0.30 XXX ±0.25 XXXX ±0.15 X: ±Z X: ±0.5	DRAWN BY : FRANK	DATE : 2014-2-23	PART NAME: MICRO USB SPIN 小牛角7.15-4.85無卷邊
UNIT: mm [inch]	CHECKED BY: DAVID	DATE : 2014-2-23	PART NO.: TMC26-USB005-485
SCALE: 1:1	APPROVED BY: TONY	DATE : 2014-2-23	MOLD NO.:
SIZE: A4			DRAW NO.:
			SHEET NO.: 10P1